



DOCKET NO.: 238663US-3993-3993-25 DIV

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IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF:

Jack D. PIPPIN : GROUP ART UNIT: 2824

SERIAL NO.: 09/707,448 : EXAMINER:

FILED: November 7, 2000 :

FOR: TEMPERATURE AVERAGING THERMAL SENSOR APPARATUS AND METHOD

REVOCATION AND NEW APPOINTMENT OF POWER OF ATTORNEY

**RECEIVED**

Assistant Commissioner for Patents  
Washington, D.C. 20231

FEB 19 2004

Sir:

Technology Center 2100

The undersigned representative of INTEL CORPORATION, owner by virtue of  
assignment of the above-identified application, hereby revokes any and all previous Powers of  
Attorney and appoints



**22850**

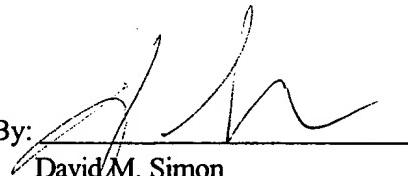
as Assignee's attorney with full power of substitution and revocation, to prosecute said patent  
application, receive any Letters Patent and to take any and all other actions with regard to this  
patent application and any Letters Patent issuing thereon, and request that all correspondence be  
sent to the firm of OBLON, SPIVAK, McCLELLAND, MAIER & NEUSTADT, P.C. whose  
Post Office Address is: 1940 Duke Street, Alexandria, Virginia 22314.



CERTIFICATION UNDER 37 C.F.R. 3.73(b)

I, the undersigned, certify that I am an individual empowered to act on behalf of INTEL CORPORATION, the assignee of the entire right, title and interest of the above-identified application by virtue of an assignment from the inventor(s), said Assignment having been recorded in the U.S. Patent and Trademark Office at reel no. 011264, frame 0928.

INTEL CORPORATION

By:   
David M. Simon  
Chief Patent Counsel

(OSMMN 2000)



OSMM&N File No. 238663US25DIV

Dept.: INT

Serial No. 09/707,448

By: CLG/WTB/wmp

In the matter of the Application of: Jack D PIPPIN

For: TEMPERATURE AVERAGING THERMAL SENSOR APPARATUS AND  
METHOD

**Due Date: NONE**

The following has been received in the U.S. Patent Office on the date stamped hereon:

- Dep. Acct. Order Form
- Cover Letter
- Status Inquiry
- Revocation and New Appointment of Power of Attorney

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